

# STD7LN80K5

### N-channel 800 V, 0.95 Ω typ., 5 A MDmesh<sup>™</sup> K5 Power MOSFET in a DPAK package

Datasheet - production data

### Features

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ID
STD7LN80K5	800 V	1.15 Ω	5 A

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### Description

This very high voltage N-channel Power MOSFET is designed using MDmesh<sup>™</sup> K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STD7LN80K5	7LN80K5	DPAK	Tape and reel

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This is information on a product in full production.

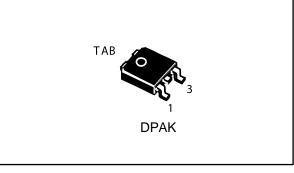


Figure 1: Internal schematic diagram

### Contents

### Contents

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 30	V
Ι <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$	5	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>c</sub> = 100 °C	3.4	А
I <sub>D</sub> <sup>(2)</sup>	Drain current (pulsed)	20	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \text{ °C}$	85	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	4.5	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
Tj	Operating junction temperature	- 55 10 150	C

#### Notes:

 $^{\left( 1\right) }Limited$  by maximum junction temperature.

 $^{\rm (2)}{\rm Pulse}$  width limited by safe operating area.

 $^{(3)}I_{SD} \leq 5$  A, di/dt  $\leq$  100 A/µs; V\_{DS peak} < V\_{(BR)DSS}, V\_{DD}{=}640 V

 $^{(4)}V_{DS} \le 640 \text{ V}$ 

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	1.47	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	50	°C/W

#### Notes:

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch², 2 oz Cu

#### Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetetive or not repetetive (pulse width limited by $T_{jmax})$	1.5	А
E <sub>AS</sub>	(Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ ; $V_{DD} = 50$ V)	200	mJ



#### 2 **Electrical characteristics**

 $T_C = 25$  °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	800			V
I <sub>DSS</sub>	Zero gate voltage Drain current	$V_{GS} = 0 V, V_{DS} = 800 V$			1	μA
		$V_{GS} = 0 V, V_{DS} = 800 V,$ $T_{C} = 125 \text{ °C}$			50	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±25 V			±10	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \ \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 2.5 A		0.95	1.15	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	270	-	pF
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	22	-	pF
Crss	Reverse transfer capacitance	$V_{GS} = 0 V$	-	0.5	-	pF
$C_{o(er)}^{(1)}$	Equivalent capacitance energy related	$V_{DS}$ = 0 to 640 V, $V_{GS}$ = 0 V	-	17	-	nC
Co(tr) <sup>(2)</sup>	Equivalent capacitance time related		-	48	-	nC
$R_{g}$	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> =0 A	-	7.5	-	Ω
$Q_g$	Total gate charge	$V_{DD}$ = 640 V, $I_D$ = 5 A, $V_{GS}$ = 10 V (see Figure 15: "Test circuit for gate charge	-	12	-	nC
$Q_{gs}$	Gate-source charge		-	2.6	-	nC
$Q_{gd}$	Gate-drain charge	behavior")	-	8.6	-	nC

#### 

#### Notes:

 $^{(1)}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDs increases from 0 to 80% V<sub>DSS</sub>

 $^{(2)}\mbox{Time}$  related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$ increases from 0 to 80% V<sub>DSS</sub>

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 400 V, $I_D$ = 2.5 A, $R_G$ = 4.7 $\Omega$ ,	-	9.3	-	ns	
tr	Rise time	V <sub>GS</sub> = 10 V (see Figure 14: "Test circuit for resistive load switching	-	6.7	-	ns	
t <sub>d(off)</sub>	Turn-off-delay time	times" and Figure 19: "Switching time	-	23.6	-	ns	
t <sub>f</sub>	Fall time	waveform")	-	17.4	-	ns	

#### Table 7: Switching times

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#### Electrical characteristics

Table 8: Source drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
I <sub>SD</sub>	Source-drain current		-		5	А	
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		20	А	
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD}$ = 5 A, $V_{GS}$ = 0 V,	-		1.6	V	
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 5$ A, di/dt = 100 A/µs, $V_{DD} = 60$ V (see Figure 16: "Test circuit for inductive load	-	276		ns	
Q <sub>rr</sub>	Reverse recovery charge		-	2.13		μC	
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	15.4		А	
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 5 A, di/dt = 100 A/µs,	-	402		ns	
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see <i>Figure 16: "Test circuit for</i>	-	2.79		μC	
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	13.9		А	

#### Notes:

 $^{(1)}\mbox{Pulse}$  width is limited by safe operating area

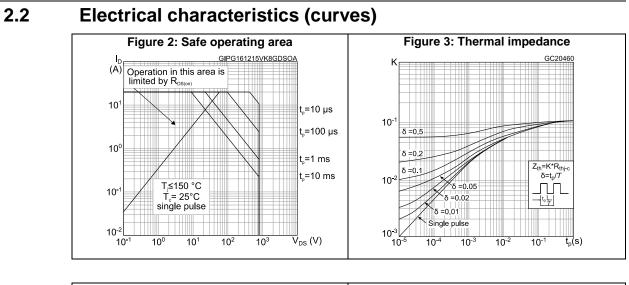
 $^{(2)}\text{Pulsed:}$  pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%

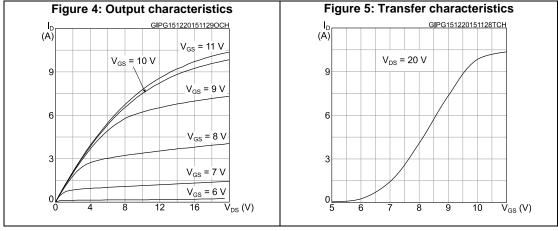
#### Table 9: Gate-source Zener diode

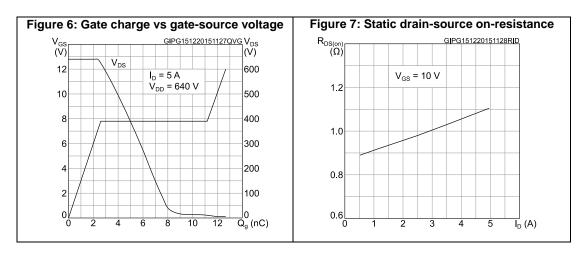
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)GSO</sub>	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-		V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.





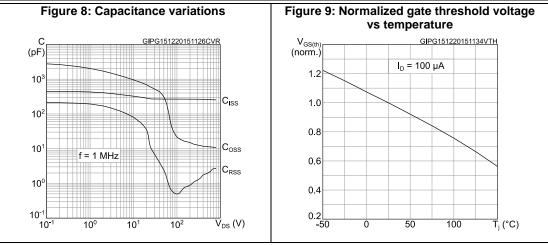


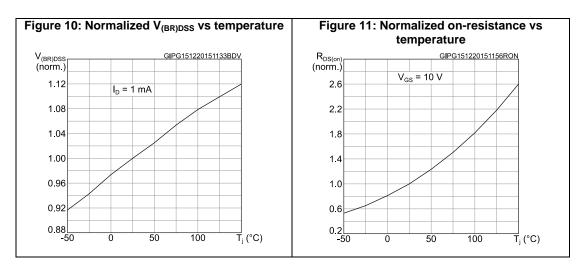


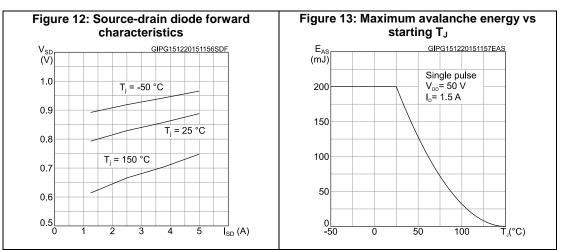


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#### **Electrical characteristics**

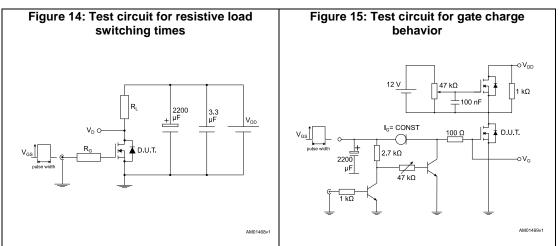


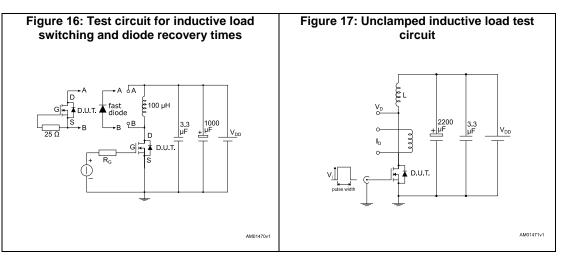


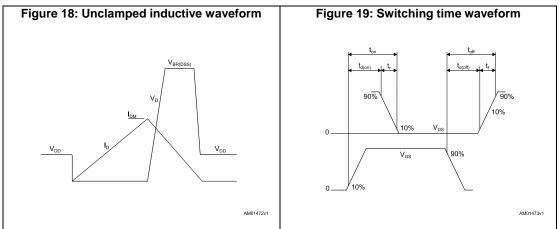


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### 3 Test circuits









### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

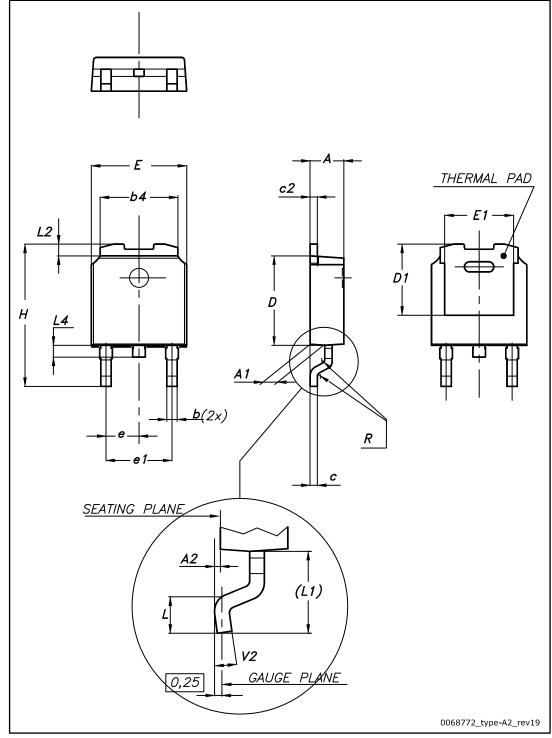


Package information

4.1 DI

### DPAK (TO-252) type A2 package information

Figure 20: DPAK (TO-252) type A2 package outline





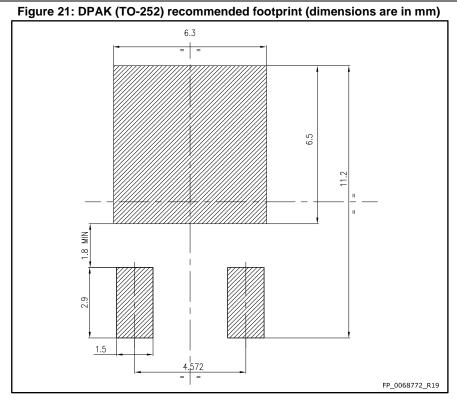
#### STD7LN80K5

K5			Package information	
	Table 10: DPAK (TO-252	2) type A2 mechanical da	ata	
Dim.	mm			
Dim.	Min.	Тур.	Max.	
А	2.20		2.40	
A1	0.90		1.10	
A2	0.03		0.23	
b	0.64		0.90	
b4	5.20		5.40	
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
D1	4.95	5.10	5.25	
E	6.40		6.60	
E1	5.10	5.20	5.30	
е	2.16	2.28	2.40	
e1	4.40		4.60	
Н	9.35		10.10	
L	1.00		1.50	
L1	2.60	2.80	3.00	
L2	0.65	0.80	0.95	
L4	0.60		1.00	
R		0.20		
V2	0°		8°	



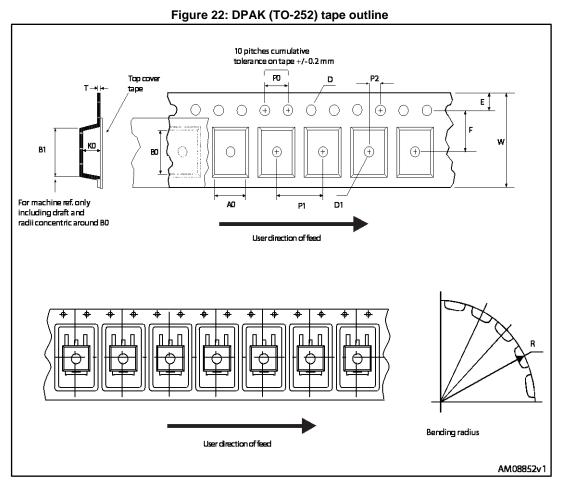
#### Package information

#### STD7LN80K5





### 4.2 DPAK (TO-252) packing information





#### Figure 23: DPAK (TO-252) reel outline

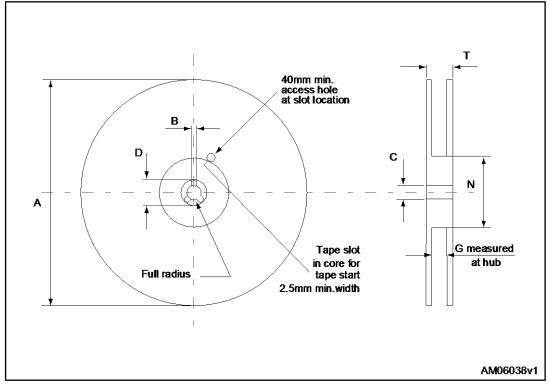


	Table 11: DPAK (TO-252) tape and reel mechanical data				
Таре			Reel		
Dim	mm		Dim	mm	
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base qty.		2500
P1	7.9	8.1	Bulk qty.		2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

### Table 11: DPAK (TO-252) tape and reel mechanical dat



### 5 Revision history

Table 12: Document revision history

Date	Revision	Changes
16-Dec-2015	1	First release.



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